**A Packaging Apparatus And Method For Transferring Integrated Circuits To A Packaging**

**Abstract**

A packaging apparatus and method for transferring integrated circuits to a packaging, the apparatus comprising: a carrier for carrying a plurality of integrated circuits and moving the plurality of integrated circuits between a location of the first packaging and a first location, the first packaging being configured for holding a plurality of integrated circuits; a first plurality of transfer units, the first plurality of transfer units being configured for transferring one or more integrated circuits from the first packaging to the carrier; and a second plurality of transfer units, the second plurality of transfer units being configured for transferring one or more integrated circuits from the carrier in the first location to one or more respective holders in a second packaging, said carrier comprising a plurality of seats for receiving integrated circuits, said carrier being configured for adjusting each received integrated circuit to assume a predetermined orientation if misalignment from the predetermined orientation occurs.

**Figure 1**